



# Product Change Notification

## 113331 - 00

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# Product Change Notification

**Change Notification #:** 113331 - 00  
**Change Title:** Intel® Server System R2308GL4GS  
PCN 113331-00, Product Design  
Update the System Rear Panel  
**Date of Publication:** October 22, 2014

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material *:</b>	November 6, 2014
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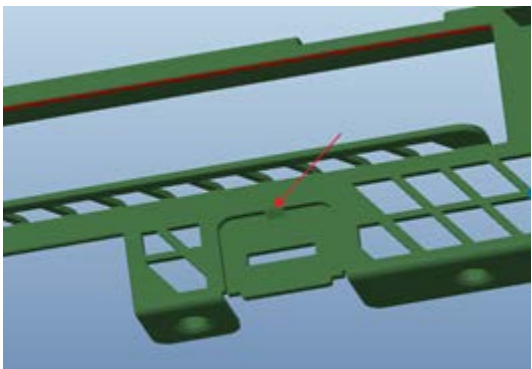
*\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

## Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server System R2308GL4GS:

1. Update the one big center joint to two smaller joints so that the joints will not conflict with the LAN cable connector latch. See Figure One.

Pre-change



Post-change

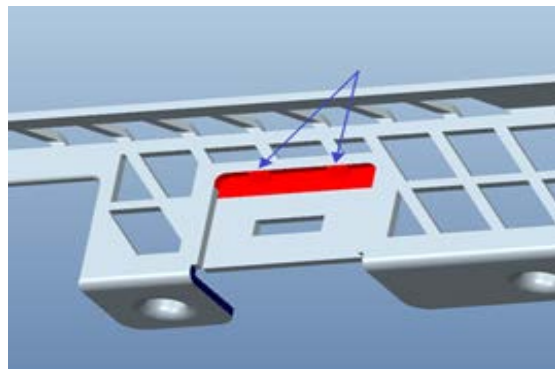


Figure One

2. Update the rear panel opening height 0.6mm higher to improve the flexibility for the cable latch. The previous height was 12.6mm+/-0.25mm. The updated height is 13.2mm+/-0.25mm. See Figure Two.

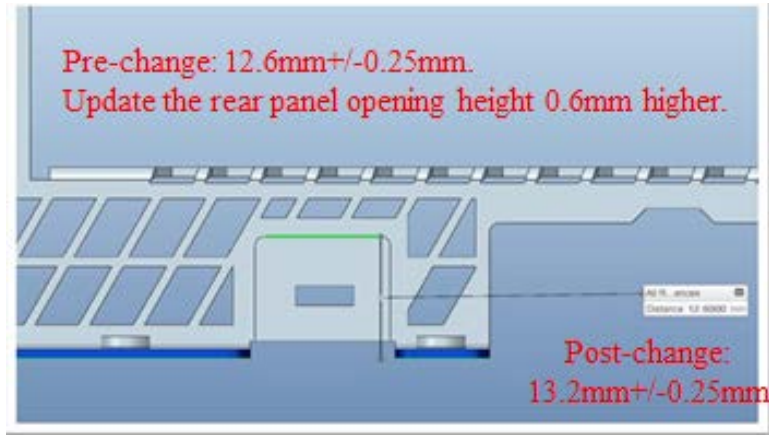


Figure Two

3. Add eight cut-offs around the on-board NIC (Network Interface Controller) openings to improve the LED visibility. See Figure Three.

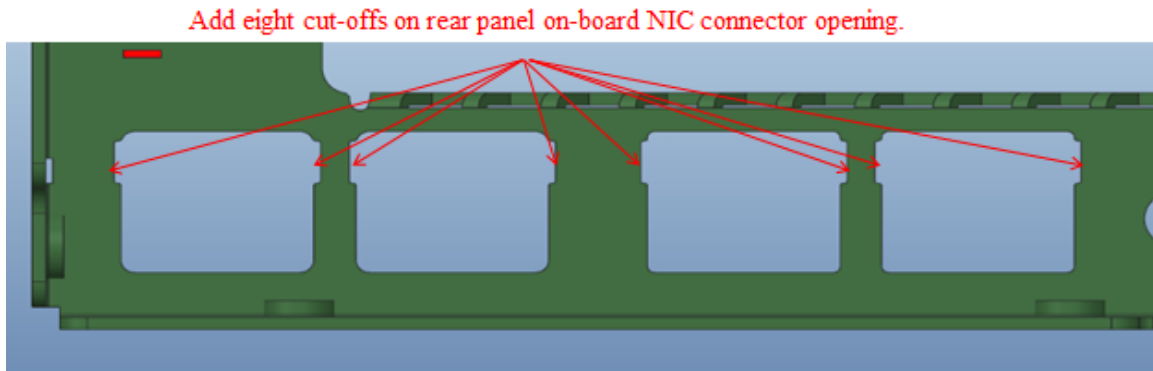


Figure Three

### Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes. Customers may need to validate the function and feature changes once the post-change system is available.

### Products Affected / Intel Ordering Codes:

EMEA SKU			
Product Code	MM#	Pre Change TA	Post Change TA
R2308GL4GS	917011	G52727-006	G52727-007

### PCN Revision History:

**Date of Revision:**  
October 22, 2014

**Revision Number:**  
00

**Reason:**  
Originally Published PCN